

IBM “MXT” Memory Compression Technology Debuts in a ServerWorks Northbridge



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ServerSet III and MXT Technology

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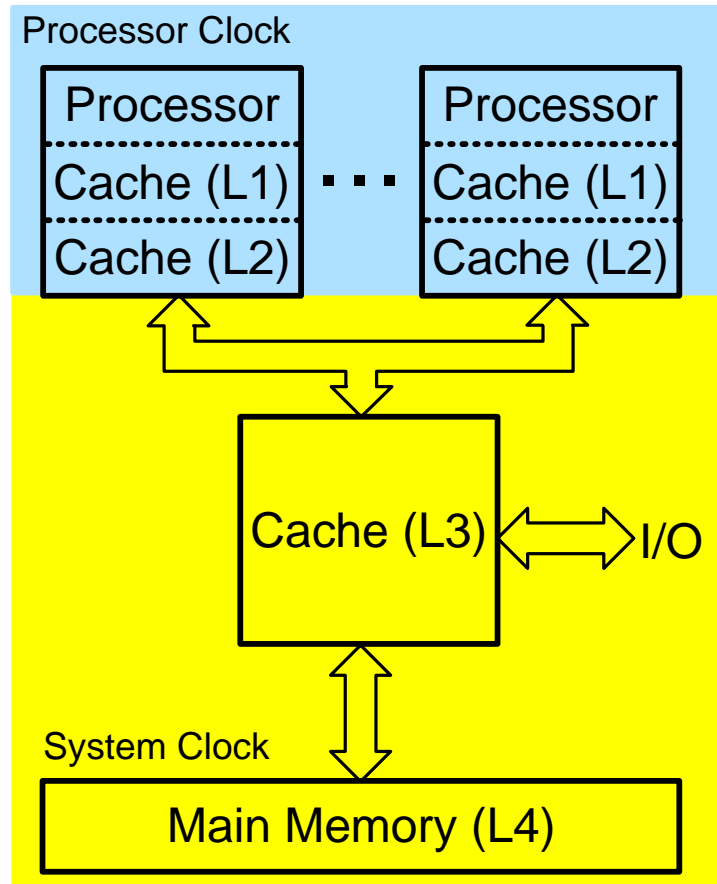
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System Architecture

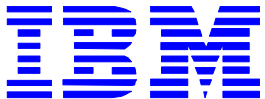
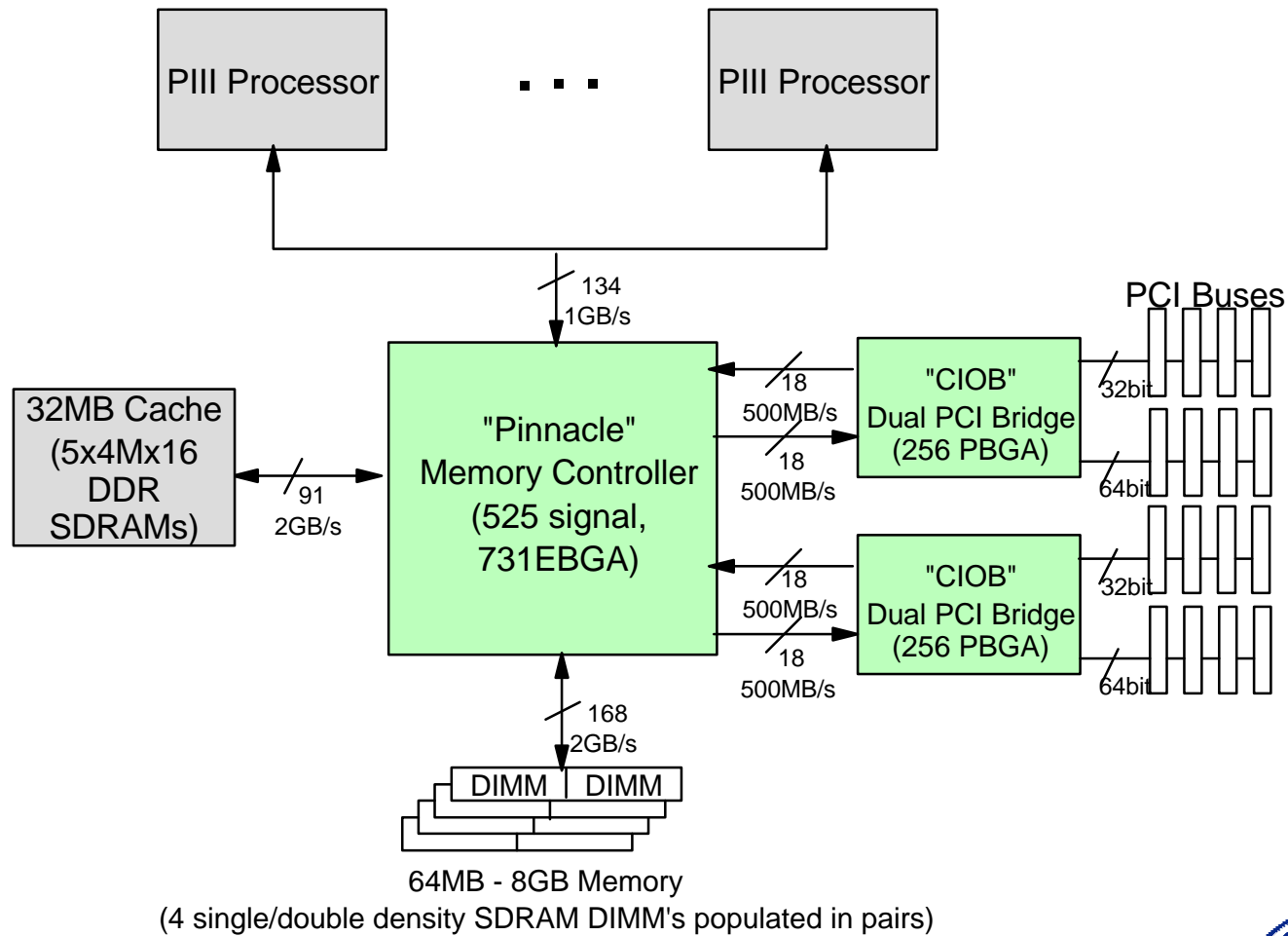


- 2-Level main memory architecture (L3/L4)
 - Fast SDRAM L3 Cache (25% - 40% faster (lower latency) than main memory)
 - L3 Cache Miss Rate < 5% (Typically 2%)
 - High Function L4 Main Memory (Sub-System Compression, Online Maintenance, Remote/Very Large Memory)
 - Function Costs Approximately \$50 - \$60
- Architectural optimization around contemporary technologies
 - 0.25 micron and smaller CMOS
 - Low-Cost high-Density packaging
 - DDR SDRAM
- Cost and performance competitive single chip memory controller for the high volume server and work station market.
 - First of its kind to employ real-time hardware compression to effectively double usable memory
 - Maintains infrequently accessed memory content stored in an efficient compressed format.



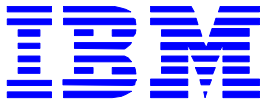
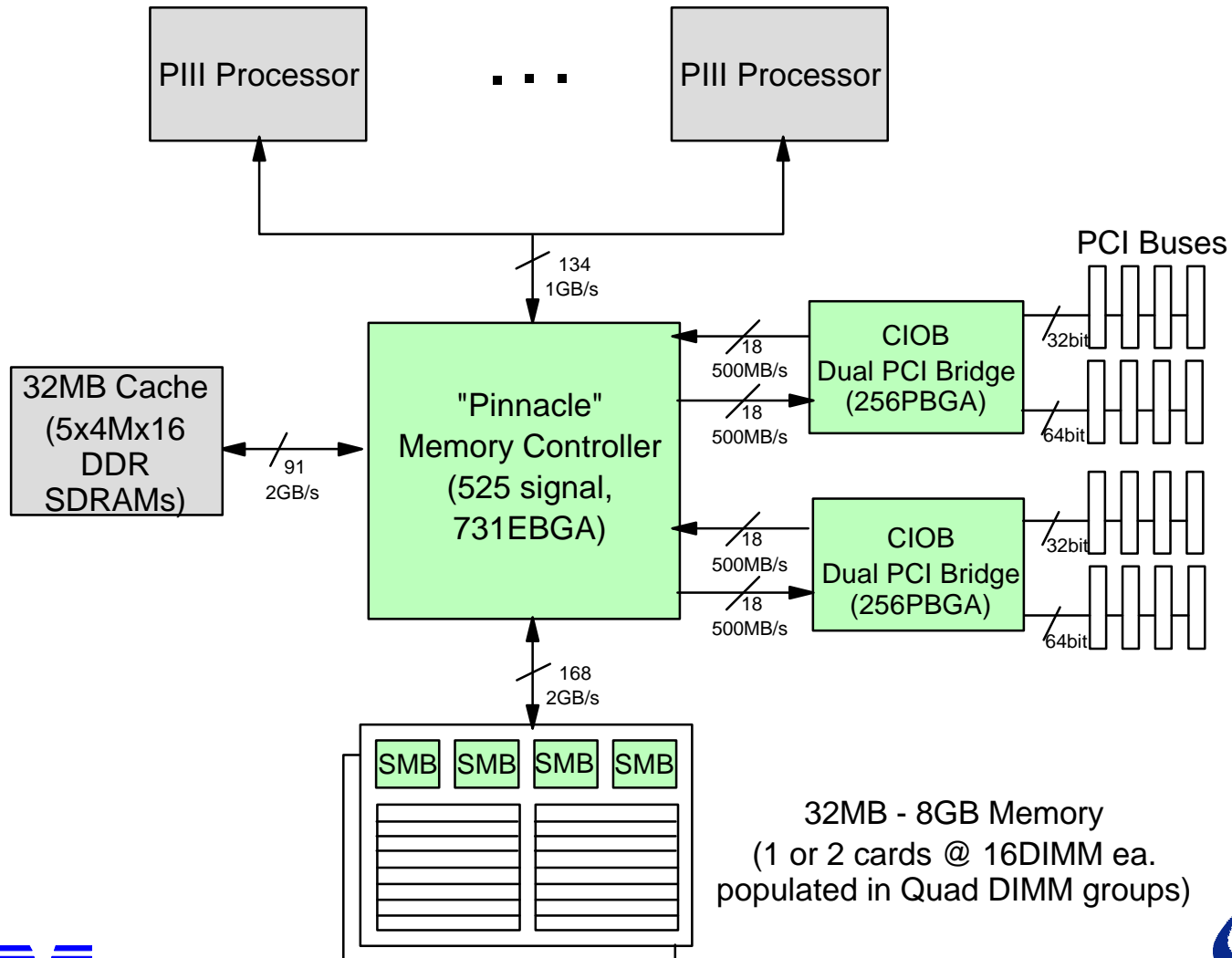
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Chip Set Memory Configurations



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Chip Set Memory Configurations



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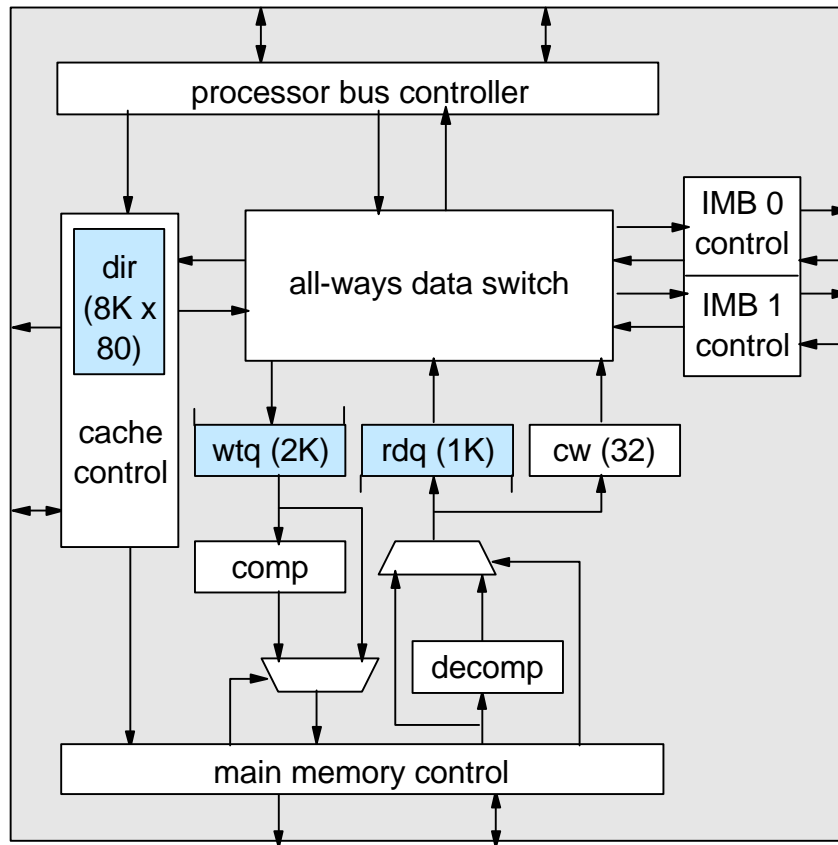
CNB30HE Features

- Single Chip: 525 signal, 731 EPGA package, 2.5VDC power, 100MHz-133MHz operation
- System Bus Interface
 - Pentium III Bus (1-4 Processors, full 36-bit address)
 - 8 Entry Request Queue
 - 8x32B Memory Write Buffer and 8x4B I/O Write Buffer
- I/O Bridge Interface (ServerWorks IMB)
 - Dual Independent Full-Duplex 500MB/s Remote Bridge links
- Cache Controller
 - Dual Ported On-Chip Directory (parity protected) Supports 16GB "Real" Addresses
 - 32MB Cache with 1KB Cache Line Size, 4-Way Set Associative
 - Reference State For Snoop Filtering (256B granularity and IO)
 - 1.6GB/s - 2GB/s access to external 32MB SDRAM DDR data cache (ECC protected)
 - Unified data/code/IO memory reference
 - LRU Replacement, Write-Back and Write-Allocate Policies
- Memory Controller
 - 16GB (uncompressed) or 8GB compressed physical memory
 - 1.6GB/s - 2GB/s Access to 8GB SDRAM Array (ECC Protected for x4 and x8 chip kill)
 - Hardware Memory Manager Unit
 - Hardware Data Compressor/Decompressor (16B/cy Decompression at 2x Clock and 4B/cy compression) for 1:1 - 64:1, real-time 1KB physical memory block compression
 - Programmed 4KB page operations for 1 microsecond speed move, swap, and clear
- Hardware Performance Monitor
- I2C Bus Interface Access to All Internal Registers



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CNB30HE Internal Architecture



- Fully pipelined 16B internal data flow at system clock frequency
- 2X system clock decompressor.
- 2 outstanding cache miss requests with writeback.
- Early cache miss "data ready" for pre-arbitration of "deferred" processor bus request.

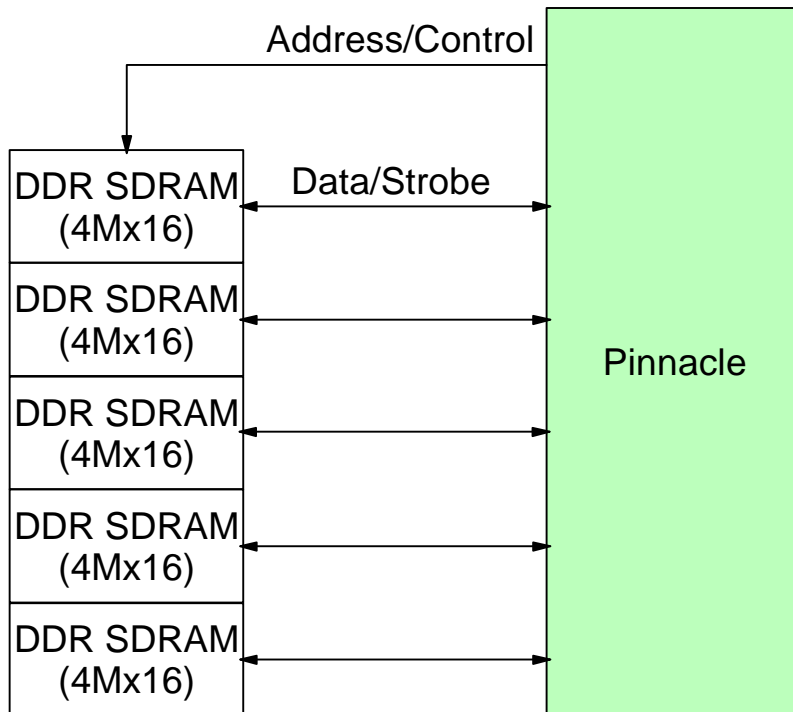
Performance

– Write	6	1	1	1
– Read, Hit Cache (SDRAM row open and hit)	8	1	1	1
– Read, Hit Cache (SDRAM row open and miss)	14	1	1	1
– Read, Hit Cache (SDRAM row closed)	14	1	1	1
– Read, Hit Cache (autoprecharge mode)	12	1	1	1
– Read, Miss Comp (avg.)	69	1	1	1
– Read, Miss Non-Comp	24	1	1	1
– Read, Miss Comp. Off	16	1	1	1



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Shared Cache



- 32MB (32K x 1024B lines), 4-way set associative cache, ECC protected
 - 5 x 4M x 16 DDR SDRAM array (burst 4)
 - 8K x 80 dual port SRAM on-chip directory
- 256B coherency granularity with IO "presence" bit.
- Special provision for two cache lines to exist within one physical line during castout.
- Independent line-fill and writeback controllers track one-another with CW fill order.
- Processor priority access to cache.

